

TRADEMARK ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
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NATURE OF CONVEYANCE:	SECURITY INTEREST
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CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type
Ekahau Oy		04/03/2006	LIMITED LIABILITY COMPANY: FINLAND

RECEIVING PARTY DATA

Name:	ETV CAPITAL S.A.
Street Address:	c/o ETV Capital Limited - 1 Tenterden Street
City:	London
State/Country:	UNITED KINGDOM
Postal Code:	W1 S1 TA
Entity Type:	CORPORATION: LUXEMBOURG

PROPERTY NUMBERS Total: 1

Property Type	Number	Word Mark
Serial Number:	78355569	EKAHAU

CORRESPONDENCE DATA

Fax Number: (404)962-6836
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: 404-885-3697
 Email: trademarks@troutmansanders.com
 Correspondent Name: Anne E. Yates, Esq.
 Address Line 1: 600 Peachtree Street, N.E.
 Address Line 2: Troutman Sanders LLP - Suite 5200
 Address Line 4: Atlanta, GEORGIA 30308-2216

ATTORNEY DOCKET NUMBER:	36800.5
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DOMESTIC REPRESENTATIVE

Name: Anne E. Yates, Esq.
 Address Line 1: 600 Peachtree Street, N.E.

OP \$40.00 78355569

Address Line 2: Troutman Sanders LLP - Suite 5200
Address Line 4: Atlanta, GEORGIA 30308-2216

NAME OF SUBMITTER:	Anne E. Yates
Signature:	/aey/
Date:	04/10/2006

Total Attachments: 6
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INTELLECTUAL PROPERTY SECURITY AGREEMENT

This Intellectual Property Security Agreement is entered into as of April 3, 2006 by and between ETV CAPITAL S.A. ("Lender") and Ekahau Oy ("Guarantor").

RECITALS

A. Lender has agreed to make certain advances of money and to extend certain financial accommodation (the "Loans") to Ekahau, Inc. (the "Borrower") in the amounts and manner set forth in that certain Venture Loan and Security Agreement by and between Lender and Borrower (the "Loan Agreement"). Lender is willing to make the Loans to Borrower, but only upon the condition, among others, that Guarantor shall grant to Lender a security interest in certain Copyrights, Trademarks and Patents to secure the obligations of Borrower under the Loan Agreement. Unless otherwise defined herein, capitalized terms used herein are used as defined in the Loan Agreement or in that certain Guaranty by and between the Lender and Guarantor (the "Guaranty").

B. Pursuant to the Guaranty Guarantor has granted to Lender a security interest in all of Guarantor's right, title and interest, whether presently existing or hereafter acquired, in, to and under all of the Intellectual Property.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, and intending to be legally bound, as collateral security for the prompt and complete payment when due of its obligations under the Loan Agreement, Guarantor hereby represents, warrants, covenants and agrees as follows:

AGREEMENT

To secure Borrower's obligations under the Loan Agreement, Guarantor grants and pledges to Lender a security interest in all of Guarantor's right, title and interest in, to and under its Intellectual Property (including without limitation those Copyrights, Patents and Trademarks listed on Schedules A, B and C hereto), and including without limitation all proceeds thereof (such as, by way of example but not by way of limitation, license royalties and proceeds of infringement suits), the right to sue for past, present and future infringements, all rights corresponding thereto throughout the world and all re-issues, divisions, continuations, renewals, extensions and continuations-in-part thereof.

This security interest is granted in conjunction with the security interest granted to Lender under the Guaranty. The rights and remedies of Lender with respect to the security interest granted hereby are in addition to those set forth in the Guaranty and the other Loan Documents, and those which are now or hereafter available to Lender as a matter of law or equity. Each right, power and remedy of Lender provided for herein or in the Guaranty or any of the Loan Documents, or now or hereafter existing at law or in equity shall be cumulative and concurrent and shall be in addition to every right, power or remedy provided for herein and the exercise by Lender of any one or more of the rights, powers or remedies provided for in this Intellectual Property Security Agreement, the Guaranty or any of the other Loan Documents, or now or hereafter existing at law or in equity, shall not preclude the simultaneous or later exercise by any person, including Lender, of any or all other rights, powers or remedies.

A

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

Address of Guarantor:

Tallberginkatu 2
00180 Helsinki
Finland

Attn: Mr. Antti Korhonen

Address of Lender:

c/o ETV Capital Limited
1 Tenterden Street
London W1 S1 TA
England

Attn: Mr. Johan Kampe /Mr. Nathaniel Norgren

GUARANTOR:

EKAHAU OY

By: 

Title: PRESIDENT & CEO

LENDER:

ETV CAPITAL S.A.

By: _____

Title: _____

IN WITNESS WHEREOF, the parties have caused this Intellectual Property Security Agreement to be duly executed by its officers thereunto duly authorized as of the first date written above.

Address of Guarantor:

Tallberginkatu 2
00180 Helsinki
Finland

Attn: Mr. Antti Korhonen

GUARANTOR:

EKAHAU OY

By: _____

Title: _____

Address of Lender:

c/o ETV Capital Limited
1 Tenterden Street
London W1 S1 TA
England

Attn: Mr. Johan Kampe /Mr. Nathaniel Norgren

LENDER

ETV CAPITAL S.A.

By:  _____

Title: _____

DIRECTORS

EXHIBIT A

Copyrights

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Registration/ Application Date</u>
N/A	N/A	N/A

EXHIBIT B

Patents

<u>Description</u>	<u>Patent/Application Number</u>	<u>Issue/Publication/ Filing Date</u>
Positioning Technique	11/030,334 (2005-0197139)	7 January 2005
Applications of signal quality observations	11/029, 642 (2005-0181804)	6 January 2005
Sequence-based positioning technique	10/999,191 (2005-0136944)	30 November 2004
Error estimate concerning a target device's location operable to move in a wireless environment	10/999,220 (2005-0131635)	30 November 2004
Probabilistic model for a positioning technique	10/999,140 (2005-0128139)	30 November 2004
Location applications for wireless networks	10/365,621 (2004-0176108)	13 February 2003
Location estimation in wireless telecommunication networks	10/465,785 (2004-0072577)	20 June 2003

EXHIBIT C

Trademarks

<u>Description</u>	<u>Registration/ Application Number</u>	<u>Status</u>	<u>Application Date</u>	<u>Owner</u>	<u>Security Interest</u>
EKAHAU	78/355569	Allowed	01/22/2004	Ekahau Oy	None recorded